

Pb Free Plating Product

## CS48N80



70V,87A N-Channel Trench Process Power MOSFET

<p><b>General Description</b></p> <p>The CS48N80 is N-channel MOS Field Effect Transistor designed for high current switching applications. Rugged E<sub>AS</sub> capability and ultra low <math>R_{DS(ON)}</math> is suitable for PWM, load switching especially for E-Bike controller applications.</p> <p><b>Features</b></p> <ul style="list-style-type: none"> <li>● <math>V_{DS}=70V</math>; <math>I_D=87A</math> @ <math>V_{GS}=10V</math>;</li> <li>    <math>R_{DS(ON)}&lt;5.8m\Omega</math> @ <math>V_{GS}=10V</math></li> <li>● Special Designed for E-Bike Controller Application</li> <li>● Ultra Low On-Resistance</li> <li>● High UIS and UIS 100% Test</li> </ul> <p><b>Application</b></p> <ul style="list-style-type: none"> <li>● 48V E-Bike Controller Applications</li> <li>● Hard Switched and High Frequency Circuits</li> <li>● Uninterruptible Power Supply</li> </ul>	 <p>CS48N80 (TO-220 HeatSink)</p> <p><b>Schematic Diagram</b></p> <p><math>V_{DSS} = 70V</math></p> <p><math>I_{DSS} = 87A</math></p> <p><math>R_{DS(ON)} = 5.5m\Omega</math></p>
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**Table 1. Absolute Maximum Ratings (TA=25°C)**

Symbol	Parameter	Value	Unit
$V_{DS}$	Drain-Source Voltage ( $V_{GS}=0V$ )	70	V
$V_{GS}$	Gate-Source Voltage ( $V_{DS}=0V$ )	$\pm 25$	V
$I_D$ (DC)	Drain Current (DC) at $T_c=25^\circ C$	87	A
$I_D$ (DC)	Drain Current (DC) at $T_c=100^\circ C$	60.9	A
$I_{DM}$ (pulse)	Drain Current-Continuous@ Current-Pulsed <sup>(Note 1)</sup>	348	A
$dv/dt$	Peak Diode Recovery Voltage	30	V/ns
$P_D$	Maximum Power Dissipation( $T_c=25^\circ C$ )	111	W
	Derating Factor	0.74	W/°C
$E_{AS}$	Single Pulse Avalanche Energy <sup>(Note 2)</sup>	552	mJ
$T_J, T_{STG}$	Operating Junction and Storage Temperature Range	-55 To 175	°C

Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature

2.Eas condition: $T_J=25^\circ C, V_{DD}=33V, V_G=10V, I_D=48A$

**Table 2. Thermal Characteristic**

Symbol	Parameter	Value	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	1.35	°C/W

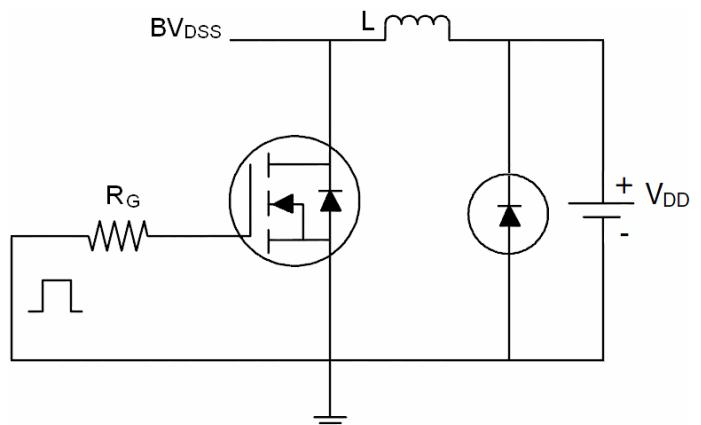
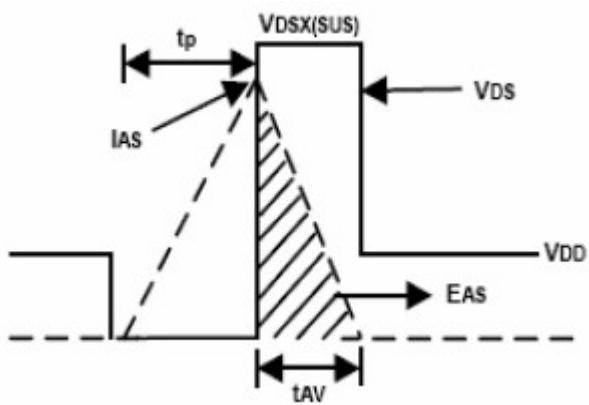
**Table 3. Electrical Characteristics (TA=25°C unless otherwise noted)**

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>On/Off States</b>						
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	70			V
$I_{DSS}$	Zero Gate Voltage Drain Current( $T_c=25^\circ C$ )	$V_{DS}=68V, V_{GS}=0V$			1	$\mu A$
$I_{DSS}$	Zero Gate Voltage Drain Current( $T_c=125^\circ C$ )	$V_{DS}=68V, V_{GS}=0V$			10	$\mu A$
$I_{GSS}$	Gate-Body Leakage Current	$V_{GS}=\pm 25V, V_{DS}=0V$			$\pm 100$	nA
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	2		4	V
$R_{DS(ON)}$	Drain-Source On-State Resistance	$V_{GS}=10V, I_D=40A$		5.5	5.8	$m\Omega$
<b>Dynamic Characteristics</b>						
$g_{FS}$	Forward Transconductance	$V_{DS}=10V, I_D=40A$		28		S
$C_{iss}$	Input Capacitance	$V_{DS}=25V, V_{GS}=0V, f=1.0MHz$		3200		pF
$C_{oss}$	Output Capacitance			350		pF
$C_{rss}$	Reverse Transfer Capacitance			320		pF
$Q_g$	Total Gate Charge	$V_{DS}=50V, I_D=40A, V_{GS}=10V$		76.1		nC
$Q_{gs}$	Gate-Source Charge			14.9		nC
$Q_{gd}$	Gate-Drain Charge			31.6		nC
<b>Switching Times</b>						
$t_{d(on)}$	Turn-on Delay Time	$V_{DD}=30V, I_D=2A, R_L=15\Omega, V_{GS}=10V, R_G=2.5\Omega$		12		nS
$t_r$	Turn-on Rise Time			14		nS
$t_{d(off)}$	Turn-Off Delay Time			25		nS
$t_f$	Turn-Off Fall Time			30		nS
<b>Source-Drain Diode Characteristics</b>						
$I_{SD}$	Source-Drain Current(Body Diode)			87		A
$I_{SDM}$	Pulsed Source-Drain Current(Body Diode)			348		A
$V_{SD}$	Forward on Voltage <sup>(Note 1)</sup>	$T_J=25^\circ C, I_{SD}=40A, V_{GS}=0V$		0.8	0.95	V
$t_{rr}$	Reverse Recovery Time <sup>(Note 1)</sup>	$T_J=25^\circ C, I_F=75A, di/dt=100A/\mu s$		45		nS
$Q_{rr}$	Reverse Recovery Charge <sup>(Note 1)</sup>			90		nC
$t_{on}$	Forward Turn-on Time	Intrinsic turn-on time is negligible(turn-on is dominated by $L_S+L_D$ )				

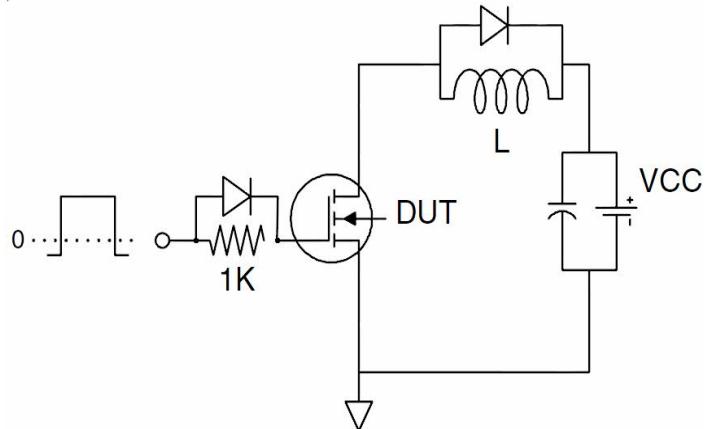
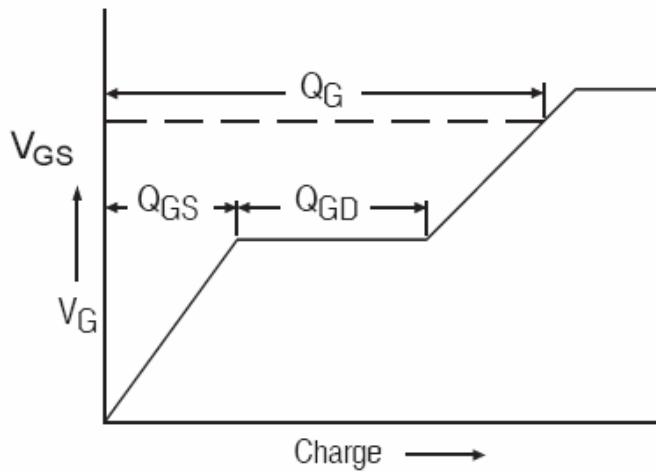
Notes 1.Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 1.5%,  $R_G=25\Omega$ , Starting  $T_J=25^\circ C$

## Test Circuit

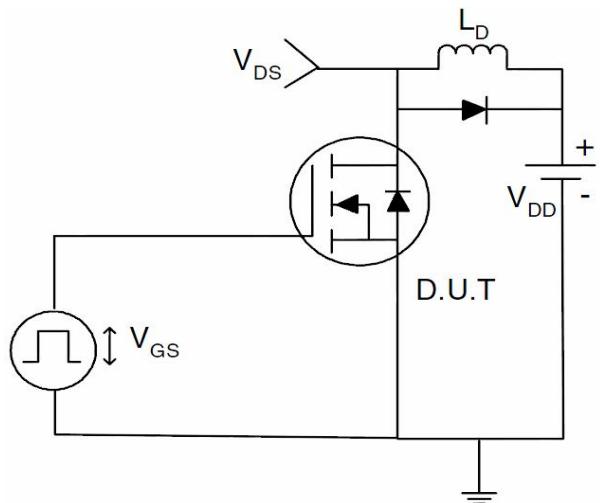
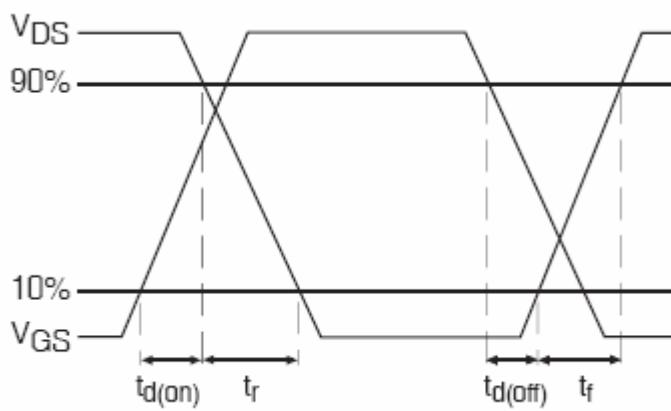
### 1) E<sub>AS</sub> Test Circuits

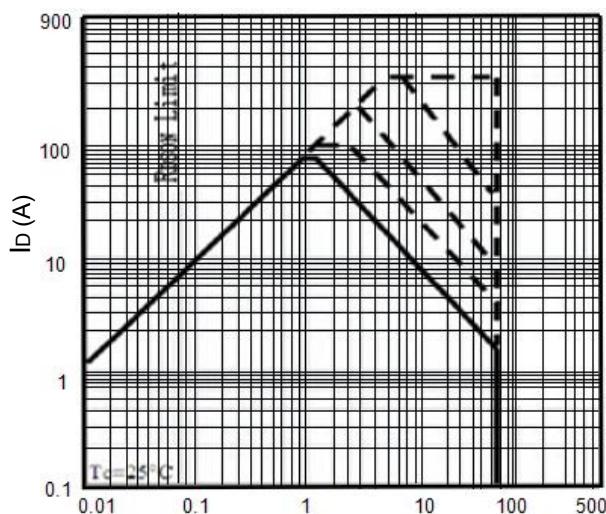
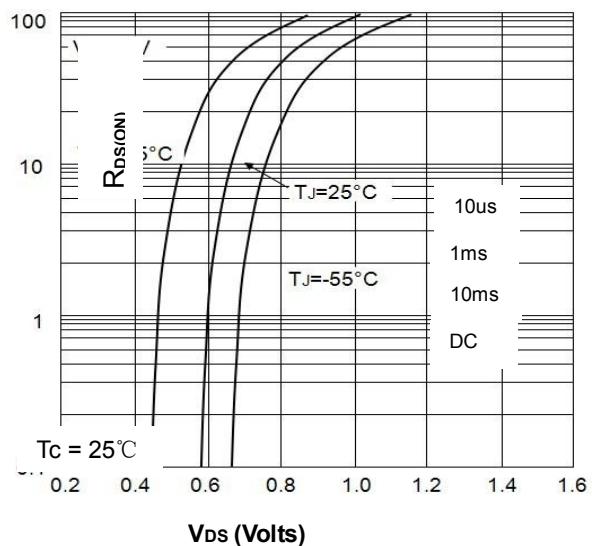
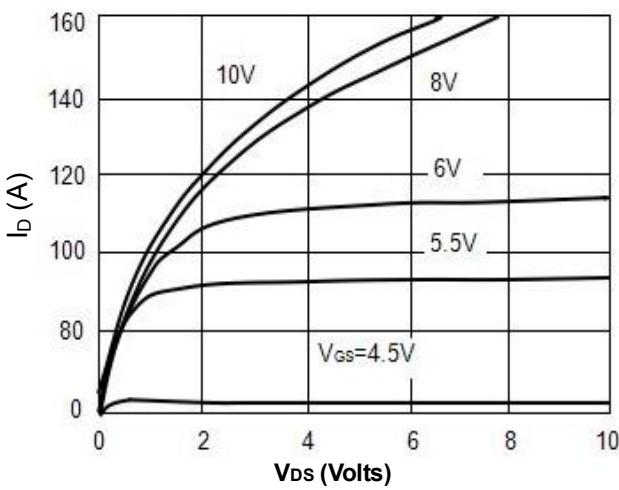
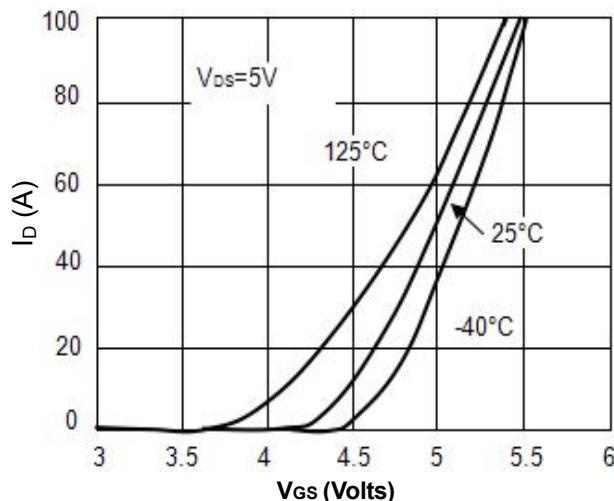
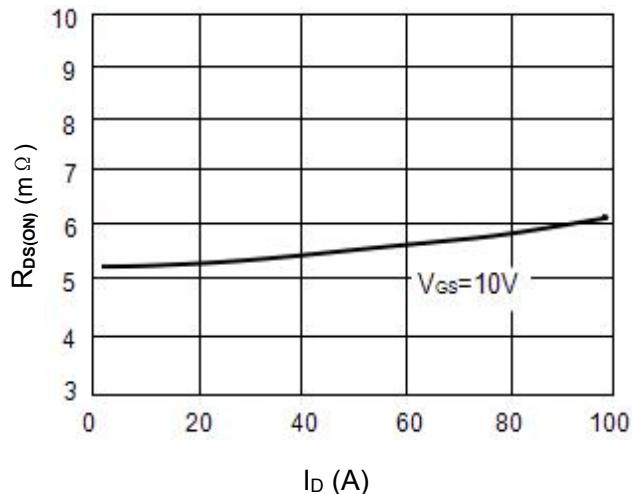
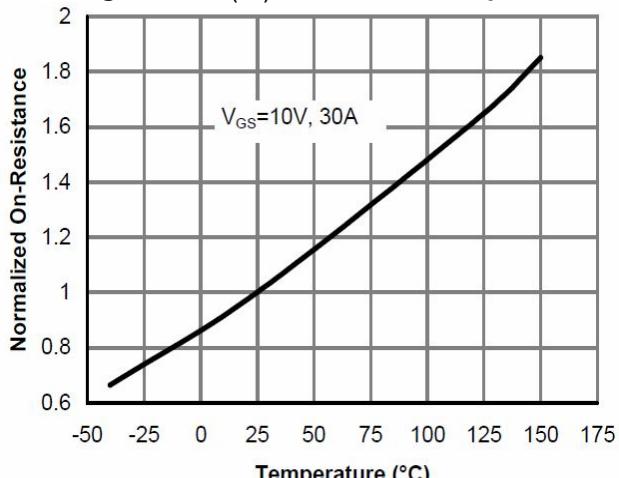


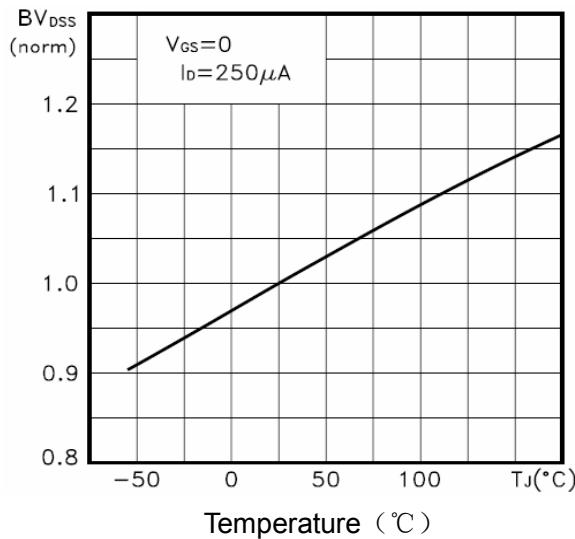
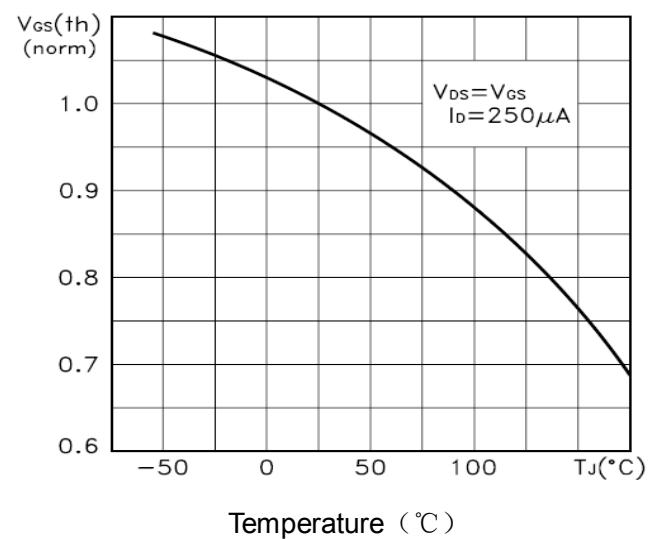
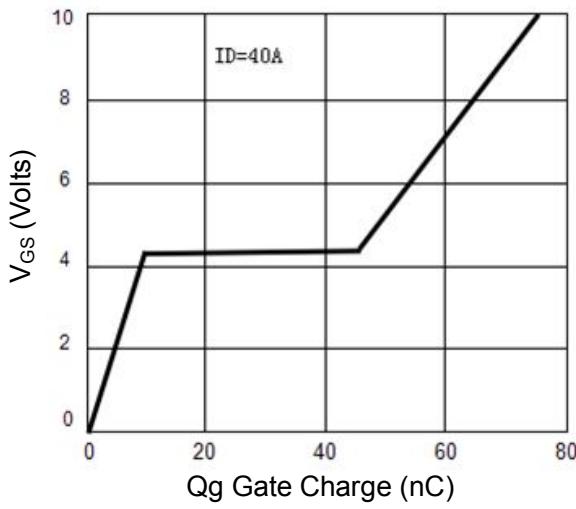
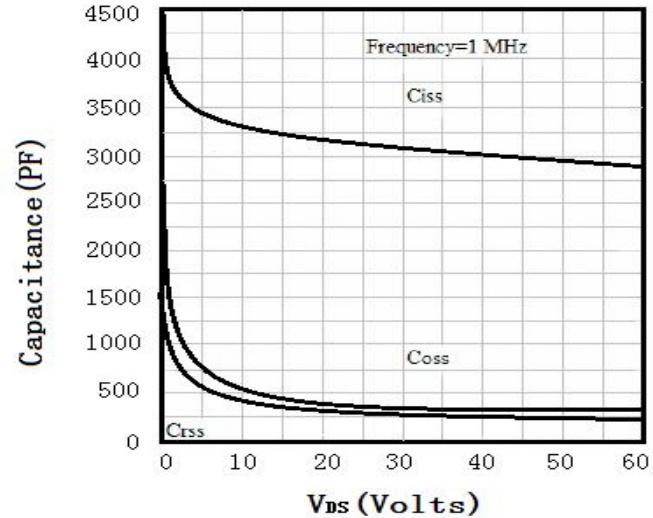
### 2) Gate charge Test Circuit:



### 3) Switch Time Test Circuit:



**TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (Curves)****Figure1. Safe Operating Area****Figure2. Source-Drain Diode Forward Voltage****Figure3. Output Characteristics****Figure4. Transfer Characteristics****Figure5. Static Drain-Source On Resistance****Figure6.  $R_{DS(\text{ON})}$  vs Junction Temperature**

**Figure7.  $BV_{DSS}$  vs Junction Temperature****Figure8.  $V_{GS(th)}$  vs Junction Temperature****Figure9. Gate Charge Waveforms****Figure10. Capacitance****Figure11. Normalized Maximum Transient Thermal Impedance**